

DATA SHEET

# SMV1247-SMV1255 Series: Hyperabrupt Junction Tuning Varactors

## Applications

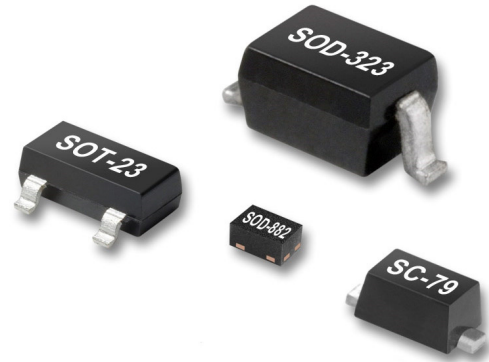
- Low tuning voltage VCOs
- High-volume commercial systems

## Features

- High capacitance ratio:  $C_{0.3V}/C_{4.7V} = 12$  typical
- Packages rated MSL1, 260 °C per JEDEC J-STD-020



Skyworks Green™ products are compliant with all applicable legislation and are halogen-free. For additional information, refer to *Skyworks Definition of Green™*, document number SQ04-0074.








## Description

The SMV1247-SMV1255 group of silicon hyperabrupt junction varactor diodes is designed for use in Voltage Controlled Oscillators (VCOs) with a low tuning voltage operation. This group of varactors is characterized for capacitance and resistance over temperature.

Table 1 describes the various packages and markings of the SMV1247 to SMV1255 varactors.

**Table 1. Packaging and Marking**

				
Single	Single	Single	Common Cathode	Single
SC-79 Green™	SOD-323 Green™	SOT-23	SOT-23	SOD-882 Green™
◆SMV1247-079LF Marking: Cathode and AH				SMV1247-040LF Marking: H
SMV1248-079LF Marking: Cathode and CH				
◆SMV1249-079LF Marking: Cathode and EH	SMV1249-011LF Marking: EF			SMV1249-040LF Marking: K
SMV1251-079LF Marking: Cathode and FH				SMV1251-040LF Marking: EH1
				SMV1253-040LF Marking: 3
SMV1253-079LF Marking: Cathode and GH			SMV1253-004LF Green™ Marking: EJ3	
				SMV1255-040LF Marking: 4
◆SMV1255-079LF Marking: Cathode and HH	SMV1255-011LF Marking: EK	SMV1255-001LF Green™ Marking: EK1		
Ls = 0.7 nH	Ls = 1.5 nH	Ls = 1.5 nH	Ls = 1.5 nH	Ls = 0.45 nH



The Pb-free symbol or “LF” in the part number denotes a lead-free, RoHS-compliant package unless otherwise noted as Green™. Tin/lead (Sn/Pb) packaging is not recommended for new designs.

## Electrical and Mechanical Specifications

The absolute maximum ratings of the SMV1247-SMV1255 group of varactors are provided in Table 2. Electrical specifications are provided in Table 3. Typical capacitance values are listed in Table 4. Typical performance characteristics of the SMV1247-SMV1255 varactors are illustrated in Figures 1 through 4.

The SPICE model for the SMV1247-SMV1255 varactors is shown in Figure 5, and the associated model parameters are provided in Table 5.

Package dimensions are shown in Figures 6 to 12 (even numbers), and tape and reel dimensions are provided in Figures 7 to 13 (odd numbers).

## Package and Handling Information

Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The SMV1247-SMV1255 group of varactors are rated to Moisture Sensitivity Level 1 (MSL1) at 260 °C. They can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, *Solder Reflow Information*, document number 200164.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.

**Table 2. SMV1247-SMV1255 Absolute Maximum Ratings<sup>1</sup>**

Parameter	Symbol	Minimum	Maximum	Units
Reverse voltage	V <sub>R</sub>		15	V
Forward current	I <sub>F</sub>		20	mA
Power dissipation	P <sub>DIS</sub>		250	mW
Operating temperature	T <sub>OP</sub>	-55	+125	°C
Storage temperature	T <sub>STG</sub>	-55	+150	°C
Electrostatic discharge:	ESD			
Charged Device Model (CDM), Class 4			1000	V
Human Body Model (HBM), Class 1A			250	V
Machine Model (MM), Class A			<50	V

<sup>1</sup> Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

**ESD HANDLING:** Although this device is designed to be as robust as possible, electrostatic discharge (ESD) can damage this device. This device must be protected at all times from ESD when handling or transporting. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD handling precautions should be used at all times.

**Table 3. SMV1247-SMV1255 Electrical Specifications<sup>1</sup>**

(T<sub>OP</sub> = 25 °C, Unless Otherwise Noted)

Part Number	C <sub>T</sub> @ 0.3 V (pF)		C <sub>T</sub> @ 4.7 V (pF)		C <sub>T</sub> @ 1 V (pF)	C <sub>T</sub> @ 3 V (pF)	C <sub>T</sub> @ 0.3 V C <sub>T</sub> @ 4.7 V (Ratio)		C <sub>T</sub> @ 1 V C <sub>T</sub> @ 3 V (Ratio)	R <sub>s</sub> @ 3 V, 500 MHz (Ω)	Q @ 3 V, 50 MHz
	Min	Typ	Typ	Max	Typ	Typ	Min	Typ	Typ	Max	Typ
SMV1247	6.5	7	0.7	0.78	4.4	0.95	9.5	10.0	4.6	6.0	1500
SMV1248	15.0	17	1.5	1.70	12.3	2.60	10.8	12.0	4.7	3.3	700
SMV1249	28.0	31	2.6	2.80	18.2	3.40	11.0	12.1	5.3	2.2	600
SMV1251	38.0	42	3.4	3.80	28.1	5.80	11.0	12.2	4.8	1.6	400
SMV1253	48.0	53	4.3	4.80	37.0	7.80	11.0	12.3	4.7	1.4	350
SMV1255	58.0	64	5.2	5.80	43.3	8.50	11.0	12.3	5.1	1.3	350

<sup>1</sup> Performance is guaranteed only under the conditions listed in this table.

Reverse voltage V<sub>R</sub> (I<sub>R</sub> = 10 μA) = 15 V minimum

Reverse current I<sub>R</sub> (V<sub>R</sub> = 12 V) = 20 nA maximum

**Table 4. Capacitance vs Reverse Voltage**

V <sub>R</sub> (V)	C <sub>T</sub> (pF)					
	SMV1247	SMV1248	SMV1249	SMV1251	SMV1253	SMV1255
0	8.86	22.62	37.35	53.65	69.32	81.21
0.5	6.17	16.32	25.88	38.23	50.23	58.28
1.0	4.37	12.33	18.18	28.09	37.07	43.27
1.5	2.96	9.12	12.08	20.13	27.57	31.49
2.0	1.88	6.27	7.27	13.55	19.37	21.50
2.5	1.22	3.93	4.44	8.60	12.39	13.40
3.0	0.95	2.57	3.40	5.78	7.77	8.51
3.5	0.83	1.95	2.96	4.57	5.77	6.51
4.0	0.77	1.71	2.72	3.95	4.86	5.58
4.5	0.73	1.59	2.51	3.58	4.34	5.07
5.0	0.70	1.49	2.38	3.33	4.01	4.76
5.5	0.68	1.44	2.30	3.16	3.78	4.58
6.0	0.67	1.40	2.24	3.03	3.62	4.46
6.5	0.66	1.36	2.19	2.94	3.50	4.39
7.0	0.65	1.33	2.14	2.88	3.41	4.33
7.5	0.64	1.31	2.09	2.83	3.34	4.29
8.0	0.64	1.30	2.03	2.79	3.28	4.26

Typical Performance Characteristics

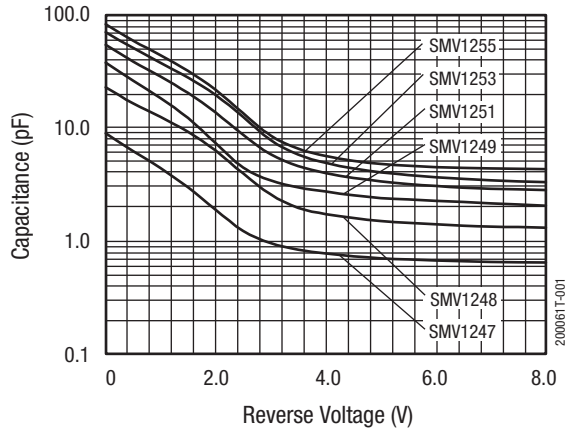


Figure 1. Capacitance vs Reverse Voltage

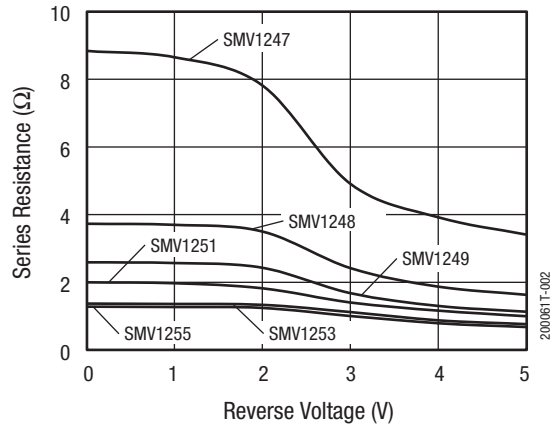


Figure 2. Series Resistance vs Reverse Voltage @ 500 MHz

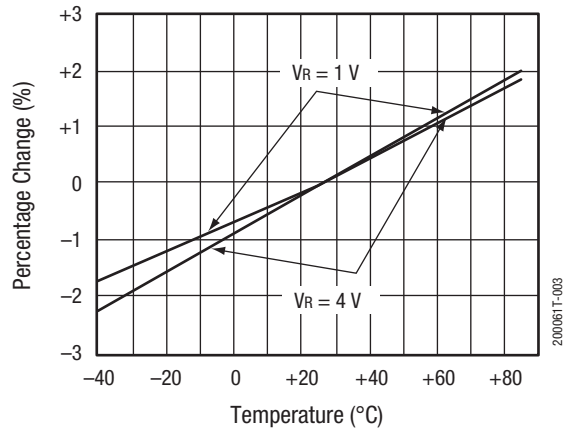


Figure 3. Relative Capacitance Change vs Temperature

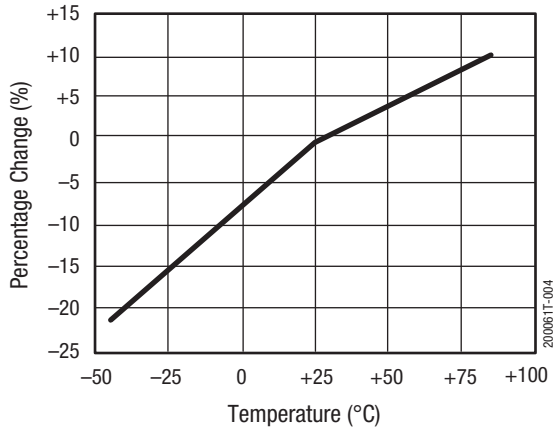


Figure 4. Relative Series Resistance Change vs Temperature @ 500 MHz

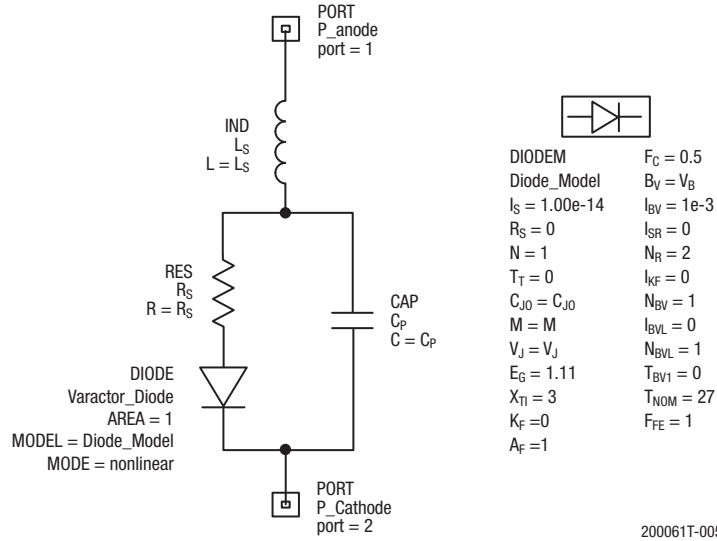


Figure 5. SPICE Model

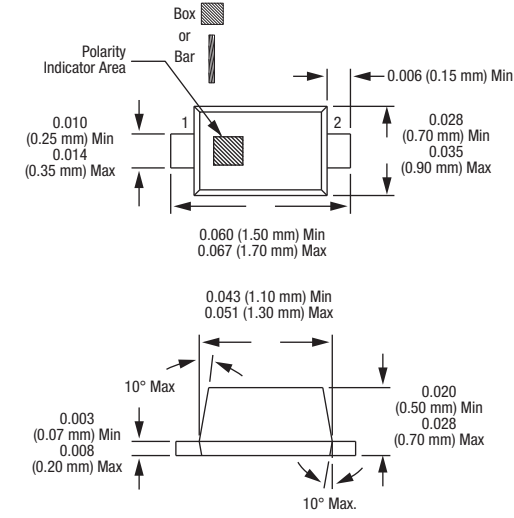
Table 5. SPICE Model Parameters<sup>1</sup>

Part Number	C <sub>J0</sub> (pF)	V <sub>J</sub> (V)	M	C <sub>p</sub> (pF)	R <sub>s</sub> (Ω)
SMV1247	8.47	80	70	0.54	4.9
SMV1248	22.12	138	100	0.87	2.4
SMV1249	36.40	80	70	1.68	1.7
SMV1251	52.48	100	76	2.00	1.4
SMV1253	51.8	73.6	48.7	2.7	1.1
SMV1255	80.00	135	100	2.74	1.0

<sup>1</sup> Model was designed to fit measured data in the range of up to 4 V.

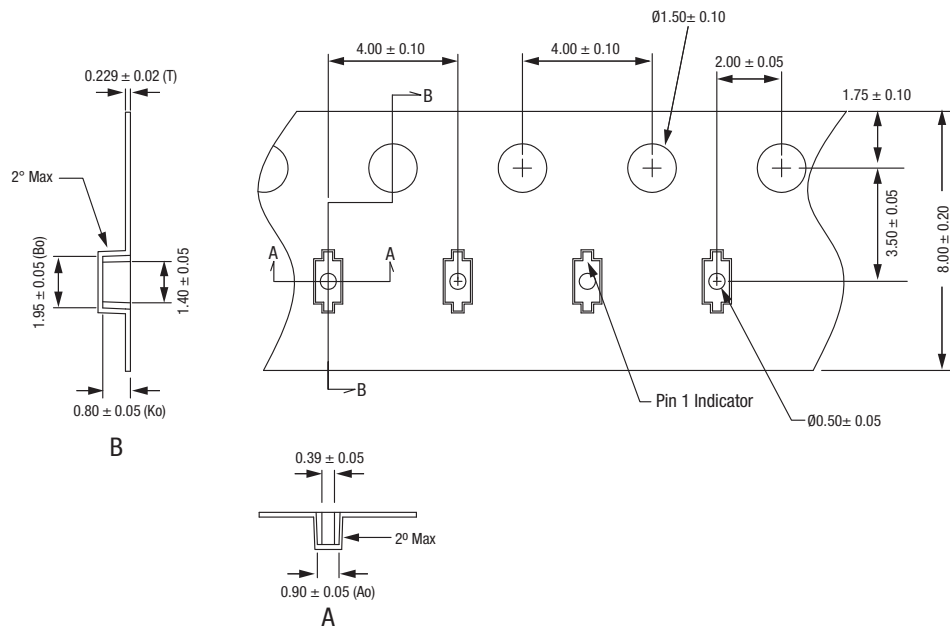
For package inductance (L<sub>s</sub>), refer to Table 1.

For more details, refer to the Skyworks Application Note, *Varactor SPICE Model for Approved RF VCO Applications*, document number 200315.



Dimensions are in inches (millimeters shown in parentheses) 200061T-006

Figure 6. SC-79 Package Dimensions

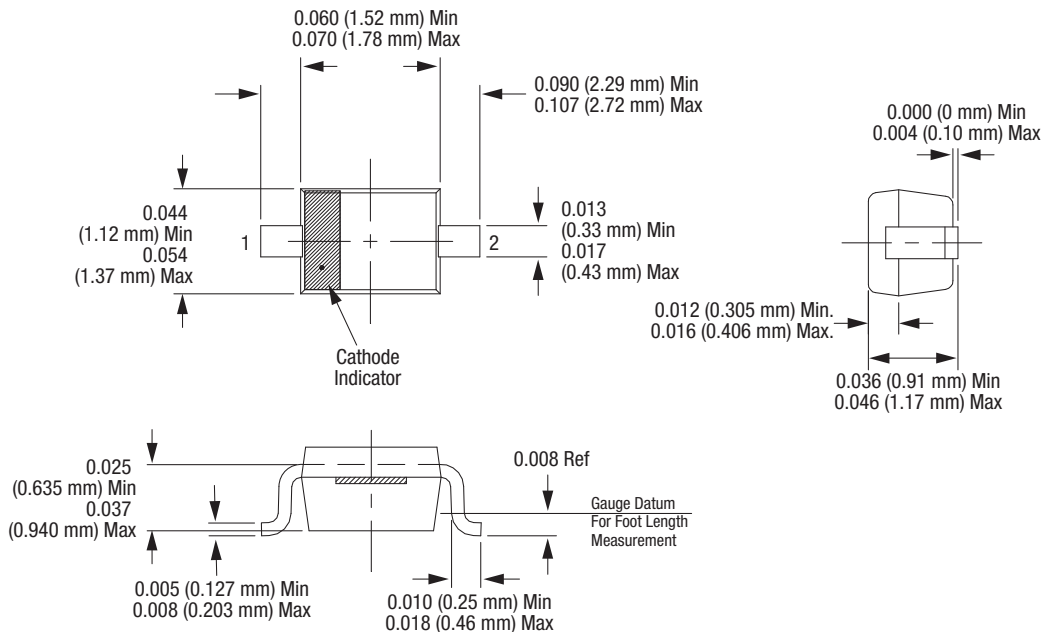


Notes:

1. Carrier tape: black conductive polycarbonate or polystyrene.
2. Cover tape material: transparent conductive PSA.
3. Cover tape size: 5.4 mm width.
4. ESD-surface resistivity is  $\leq 1 \times 10^9$  Ohms/square per EIA, JEDEC TNR Specification.
5. All measurements are in millimeters.

200061T-007

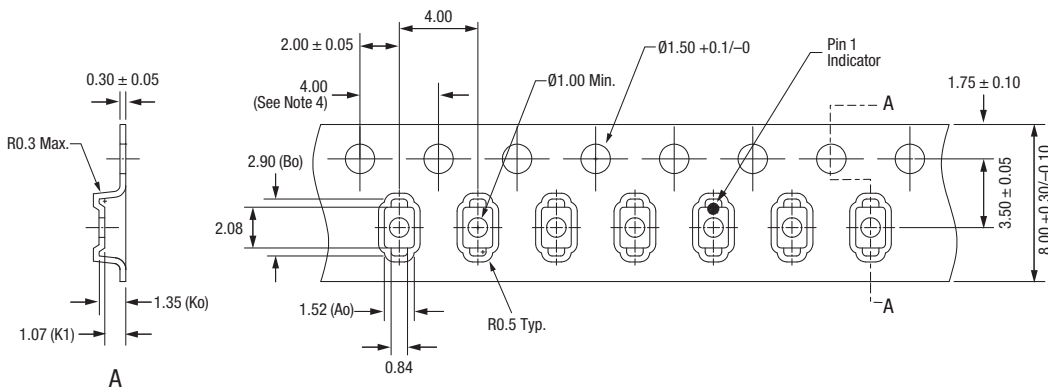
Figure 7. SC-79 Tape and Reel Dimensions



Dimensions are in inches (millimeters shown in parentheses)

200061T-008

Figure 8. SOD-323 Package Dimensions



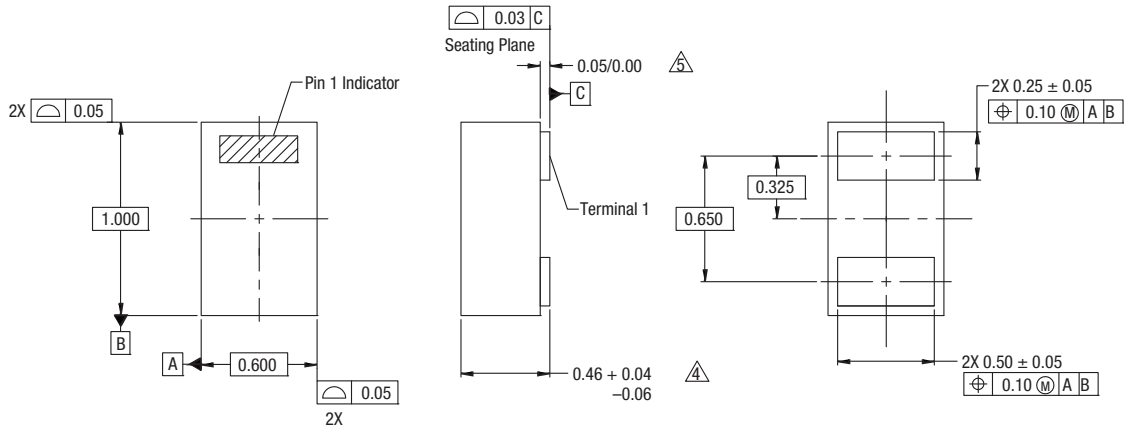
Notes:

1. Carrier tape: black conductive polystyrene.
2. Cover tape: transparent conductive PSA.
3. Cover tape size: 5.4 mm width.
4. 10 sprocket hole pitch cumulative tolerance: ±0.20 mm.
5. All measurements are in millimeters.

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Figure 9. SOD-323 Tape and Reel Dimensions



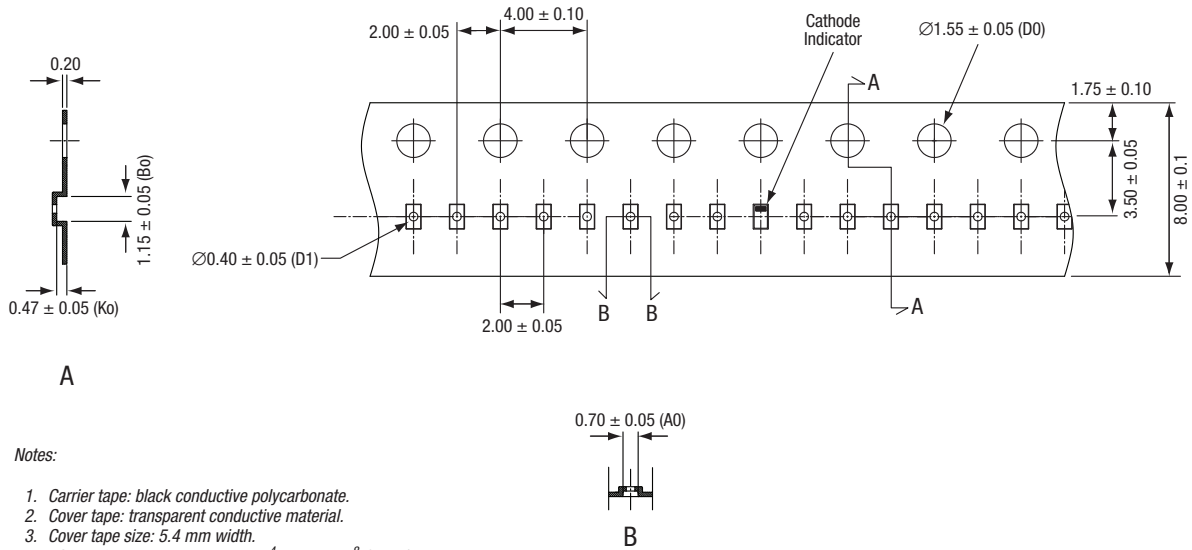


Notes:

1. All measurements are in millimeters.
2. Dimensions and tolerances according to ASME Y14.5M-1994.
3. These packages are used principally for discrete devices.
4. This dimension includes stand-off height and package body thickness, but does not include attached features, e.g., external heatsink or chip capacitors. An integral heatslug is not considered an attached feature.
5. This dimension is primarily terminal plating, but does not include small metal protrusion.

200061T-010

Figure 10. SOD-882 Package Dimensions

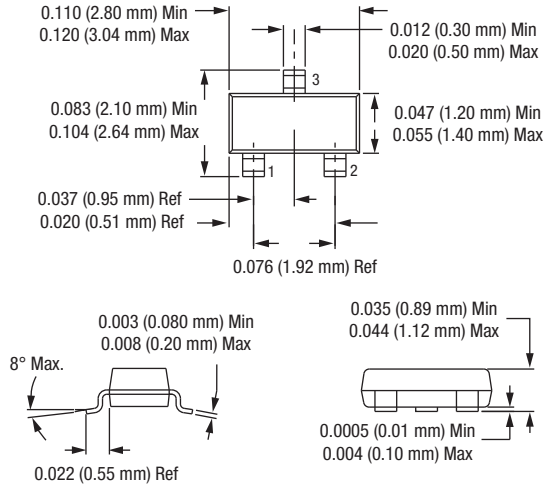


Notes:

1. Carrier tape: black conductive polycarbonate.
2. Cover tape: transparent conductive material.
3. Cover tape size: 5.4 mm width.
4. ESD surface resistivity is  $\geq 1 \times 10^4 \sim \leq 1 \times 10^8$  Ohms/square.
5. All dimensions are in millimeters.

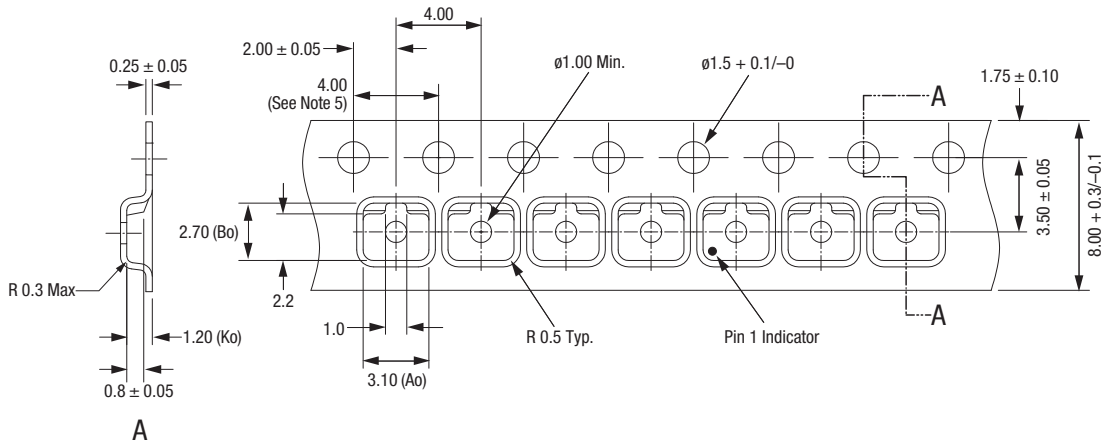
200061T-011

Figure 11. SOD-882 Tape and Reel Dimensions



Dimensions are in inches (millimeters shown in parentheses) 200061T-012

Figure 12. SOT-23 Package Dimensions



Notes:

1. Carrier tape: black conductive polycarbonate.
2. Cover tape material: transparent conductive PSA.
3. Cover tape size: 5.40 mm width.
4. Tolerance: ±0.10 mm.
5. 10-sprocket hole pitch cumulative tolerance: ±0.2 mm.
6. All measurements are in millimeters.
7. Alternative carrier tape dimensions are:  
 A0 = 3.3  
 B0 = 2.9  
 K0 = 1.22

200061T-013

Figure 13. SOT-23 Tape and Reel Dimensions